

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT						
NATURE OF CONVEYANCE:	ASSIGNMENT						
CONVEYING PARTY DATA							
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Wenge Yang</td> <td>07/09/1998</td> </tr> <tr> <td>Lewis Shen</td> <td>07/09/1998</td> </tr> </tbody> </table>		Name	Execution Date	Wenge Yang	07/09/1998	Lewis Shen	07/09/1998
Name	Execution Date						
Wenge Yang	07/09/1998						
Lewis Shen	07/09/1998						
RECEIVING PARTY DATA							
Name:	Advanced Micro Devices, Inc.						
Street Address:	One AMD Place						
Internal Address:	P.O. Box 3453						
City:	Sunnyvale						
State/Country:	CALIFORNIA						
Postal Code:	94088-3453						
PROPERTY NUMBERS Total: 1							
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Patent Number:</td> <td>6383939</td> </tr> </tbody> </table>		Property Type	Number	Patent Number:	6383939		
Property Type	Number						
Patent Number:	6383939						
CORRESPONDENCE DATA							
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<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>							
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ATTORNEY DOCKET NUMBER:	4186.5930001						
NAME OF SUBMITTER:	Michael Q. Lee						
Signature:	/Michael Q. Lee, Reg. No. 35,239/						
Date:	09/27/2013						
Total Attachments: 2 source=4186.5930001 - Assignment from Inventors to AMD#page1.tif source=4186.5930001 - Assignment from Inventors to AMD#page2.tif							

OP \$40.00 6383939

Docket No.: 50100-535

ASSIGNMENT

WHEREAS WE, WENGE YANG and LEWIS SHEN of Fremont, CA and Cupertino, CA, respectively, have made a certain new and useful invention as set forth in an application for United States Letters Patent, entitled METHOD FOR ETCHING MEMORY GATE STACK USING THIN RESIST LAYER, executed by us on the date of execution of this document, as shown below, and filed concurrently herewith; OR

AND WHEREAS, Advanced Micro Devices, Inc., a corporation of the State of Delaware and having an address of One AMD Place, P. O. Box 3453, Sunnyvale, California 94088-3453 is desirous of acquiring the entire right, title and interest in and to said invention and in and to any and all Letters Patent of the United States and foreign countries which may be obtained therefor;

NOW, THEREFORE, for good and valuable consideration, the receipt for and sufficiency of which is hereby acknowledged, We do hereby sell, assign, transfer and set over unto Advanced Micro Devices, Inc., its legal representatives, successors, and assigns, the entire right, title and interest in and to said invention as set forth in the above-mentioned application, including any continuations, continuations-in-part, divisions, reissues, re-examinations or extensions thereof, and in and to any and all patents of the United States and foreign countries which may be issued for said invention;

UPON SAID CONSIDERATIONS, We hereby agree with the said assignee that We will not execute any writing or do any act whatsoever conflicting with these presents, and that We will, at any time upon request, without further or additional consideration but at the expense of said assignee, execute such additional assignments and other writings and do such additional acts as said assignee may deem necessary or desirable to perfect the assignee's enjoyment of this grant, and render all necessary assistance in making application for and obtaining original, divisional, continuations, continuations-in-part, reexamined, reissued, or extended Letters Patent of the United States or of any and all foreign countries on said invention, and in enforcing any rights or choses in action accruing as a result of such applications or patents, by giving testimony in any proceedings or transactions involving such applications or patents, and by executing preliminary statements and other affidavits, it being understood that the foregoing covenant and agreement shall bind, and inure to the benefit of the assigns and legal representatives of assignor and assignee;

AND We request the Commissioner of Patents and Trademarks to issue any Letters Patent of the United States which may be issued for said invention to said Advanced Micro Devices, Inc., its legal representatives, successors or assigns, as the sole owner of the entire right, title and interest in and to said patent and the invention covered thereby.

7/9/98
Date

Wenge Yang
WENGE YANG

7/9/98
Date

Lewis Shen
LEWIS SHEN

Date

Date

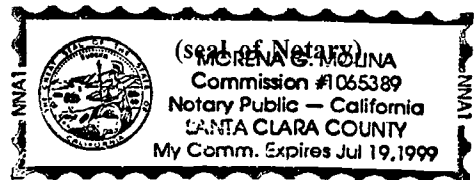
STATE OF CALIFORNIA)
)
) SS:
COUNTY OF Santa Clara)

On July 9, 1999, before me, Morena G. Molina, Notary Public,
personally appeared WENGE YANG,
personally known to me (or proved to me on the basis of satisfactory evidence) to be the person(s) whose name(s) is/are
subscribed to the within instrument and acknowledged to me that he/~~she~~/they executed the same in his/~~her~~/their
authorized capacity(ies), and that by his/~~her~~/their signature(s) on the instrument the person(s), or the entity upon behalf
of which the person(s) acted, executed the instrument.

WITNESS my hand and official seal.

Morena G. Molina (signature of Notary)

My commission expires July 19, 1999.



STATE OF CALIFORNIA)
)
) SS:
COUNTY OF Santa Clara)

On July 9, 1998, before me, Morena G. Molina, Notary Public,
personally appeared LEWIS SHEN,
personally known to me (or proved to me on the basis of satisfactory evidence) to be the person(s) whose name(s) is/are
subscribed to the within instrument and acknowledged to me that he/~~she~~/they executed the same in his/~~her~~/their
authorized capacity(ies), and that by his/~~her~~/their signature(s) on the instrument the person(s), or the entity upon behalf
of which the person(s) acted, executed the instrument.

WITNESS my hand and official seal.

Morena G. Molina (signature of Notary)

My commission expires July 19, 1999.

